



THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Bin Zhao

Serial No.: 09/686,323

Filed: October 9, 2000

For: Method of Fabricating an

Interconnect Structure Employing Air Gaps Between Metal Lines and

Between Metal Layers

Art Unit: 2814

Examiner: Peralta, Ginette

Iethod of Fabricating an atterconnect Structure Employing ir Gaps Between Metal Lines and etween Metal Layers AMENDMENT AND RESPONSE TO NON-FINAL OFFICE ACTION

Honorable Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir/Madam:

This is in response to the non-final Office Action dated July 28, 2003 in the abovereferenced patent application. Please enter and consider the following amendments and remarks.